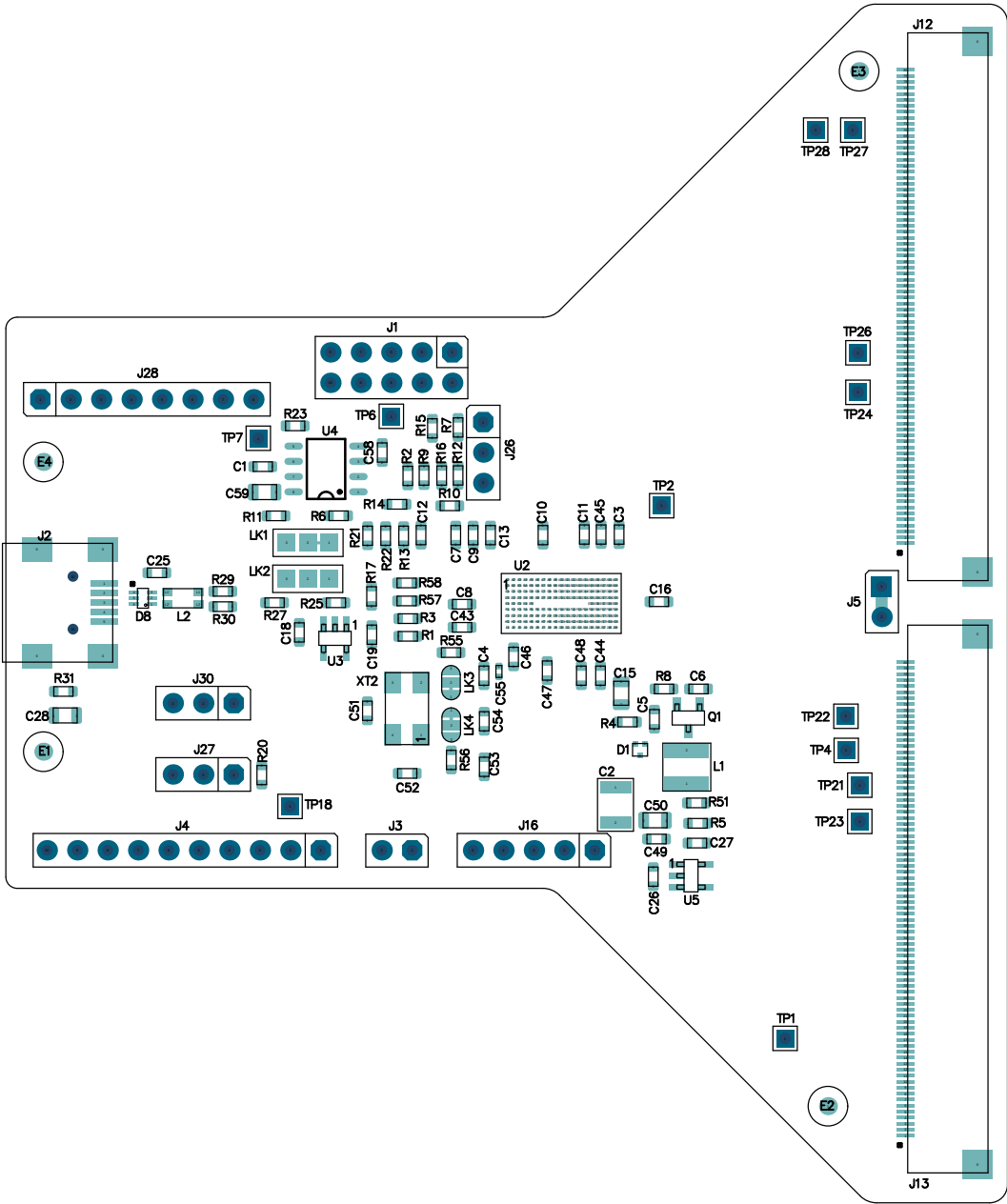
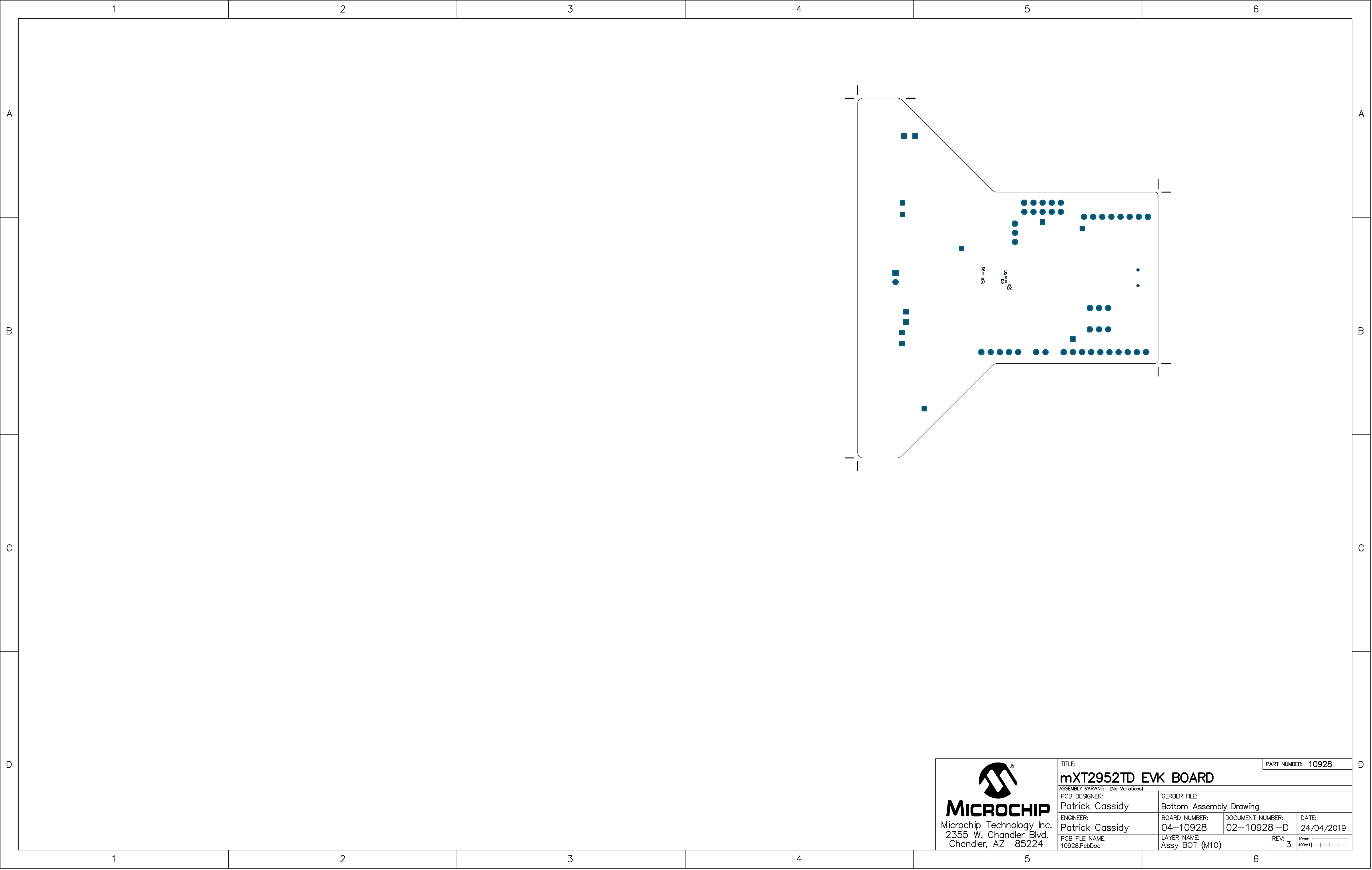




ASSEMBLY NOTES:

1. ALL COMPONENTS SHALL BE RoHS COMPLIANT.
2. ALL UNUSED THROUGH HOLE COMPONENT LOCATIONS SHALL BE FREE OF SOLDER.
3. ALL TEST POINT THROUGH HOLES (DENOTED TPxx) SHALL BE FREE OF SOLDER.
4. ALL COMPONENTS SHALL BE MOUNTED FLUSH TO THE BOARD, EXCEPT AS NOTED.
5. FINISHED BOARD SHALL BE FREE OF ALL RESIDUES.
6. ALL LEADS SHALL BE TRIMMED TO A MAXIMUM HEIGHT OF 2mm.
7. PLACE LABEL ON THE LOCATION INDICATED.

 MICROCHIP Microchip Technology Inc. 2355 W. Chandler Blvd. Chandler, AZ 85224	TITLE: mXT2952TD EVK BOARD			PART NUMBER: 10928	
	ASSEMBLY VARIANT: (No Variations)				
	PCB DESIGNER: Patrick Cassidy		GERBER FILE: Top Assembly Drawing		
	ENGINEER: Patrick Cassidy		BOARD NUMBER: 04-10928	DOCUMENT NUMBER: 02-10928 -D	DATE: 24/04/2019
	PCB FILE NAME: 10928.PcbDoc		LAYER NAME: Assy TOP (M11)		REV: 3
10mm 400mil 					



TITLE:		PART NUMBER: 10928	
mXT2952TD EVK BOARD			
ASSEMBLY VARIANT: (No Variations)			
PCB DESIGNER: Patrick Cassidy		GERBER FILE: Bottom Assembly Drawing	
ENGINEER: Patrick Cassidy		BOARD NUMBER: 04-10928	DOCUMENT NUMBER: 02-10928-D
PCB FILE NAME: 10928.PcbDoc		LAYER NAME: Assy BOT (M10)	DATE: 24/04/2019
		REV: 3	10mm 400mil

